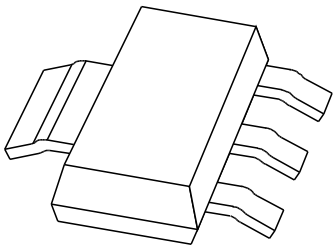
DATA SHEET



PZTA56
PNP general purpose transistor

Product specification
Supersedes data of September 1994
File under Discrete Semiconductors, SC04

1997 Apr 01

Philips
Semiconductors

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PNP general purpose transistor PZTA56

FEATURES

- Low current (max. 500 mA)
- Low voltage (max. 80 V).

APPLICATIONS

- Telephony and professional communication equipment.

DESCRIPTION

PNP transistor in a SOT223 plastic package.
NPN complement: PZTA06.

PINNING

PIN	DESCRIPTION
1	base
2, 4	collector
3	emitter

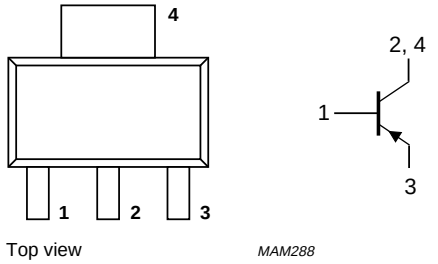


Fig.1 Simplified outline (SOT223) and symbol.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–80	V
V_{CEO}	collector-emitter voltage	open base	–	–80	V
I_{CM}	peak collector current		–	–1	A
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	–	1.2	W
h_{FE}	DC current gain	$I_C = -100$ mA; $V_{CE} = -1$ V	100	–	
f_T	transition frequency	$I_C = -100$ mA; $V_{CE} = -1$ V; f = 100 MHz	50	–	MHz

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–80	V
V_{CEO}	collector-emitter voltage	open base	–	–80	V
V_{EBO}	emitter-base voltage	open collector	–	–5	V
I_C	collector current (DC)		–	–500	mA
I_{CM}	peak collector current		–	–1	A
I_{BM}	peak base current		–	–200	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C; note 1	–	1.2	W
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C
T_{amb}	operating ambient temperature		–65	+150	°C

Note

1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm^2.
   For other mounting conditions, see *"Thermal considerations for SOT223 in the General part of handbook SC04"*.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j\text{-}a}$	thermal resistance from junction to ambient	note 1	103	K/W
$R_{th\ j\text{-}s}$	thermal resistance from junction to soldering point		22	K/W

Note

1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm^2.
   For other mounting conditions, see *"Thermal considerations for SOT223 in the General part of handbook SC04"*.

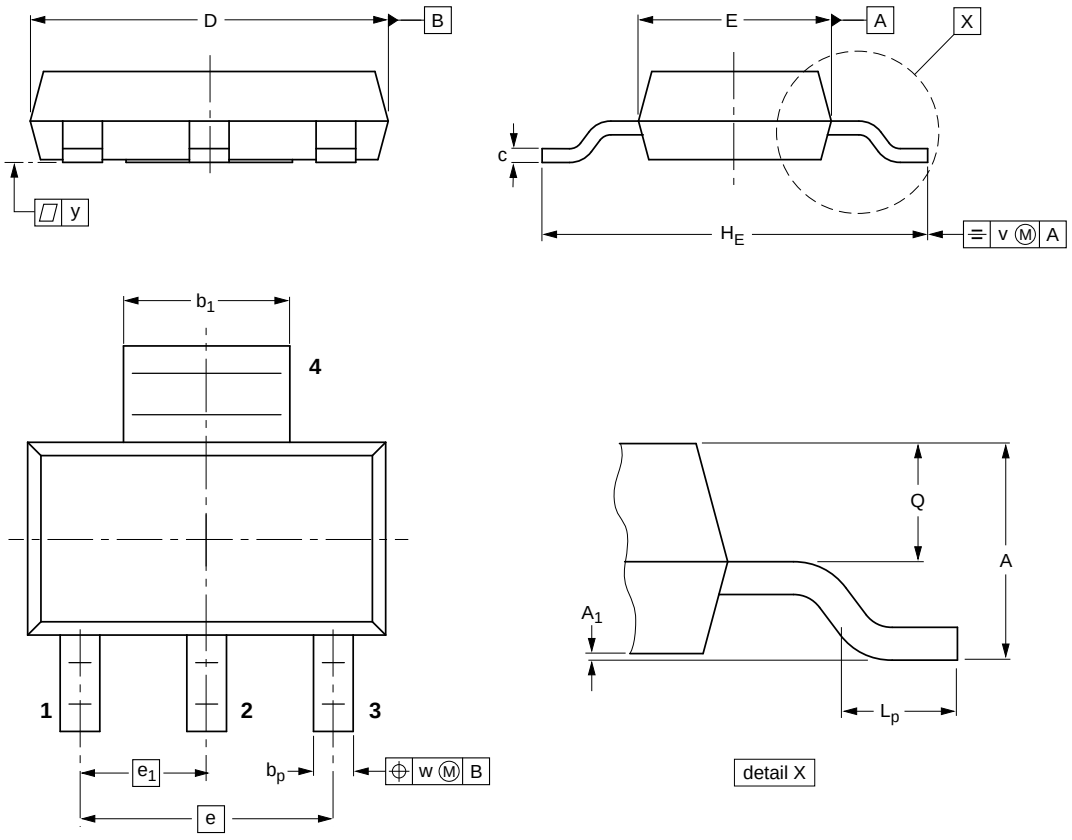
CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0$; $V_{CB} = –80$ V	–	–50	nA
I_{EBO}	emitter cut-off current	$I_C = 0$; $V_{EB} = –5$ V	–	–50	nA
h_{FE}	DC current gain	$I_C = –10$ mA; $V_{CE} = –1$ V	100	–	
		$I_C = –100$ mA; $V_{CE} = –1$ V	100	–	
V_{CEsat}	collector-emitter saturation voltage	$I_C = –100$ mA; $I_B = –10$ mA	–	–250	mV
V_{BE}	base-emitter voltage	$I_C = –100$ mA; $V_{CE} = –1$ V	–	–1.2	V
f_T	transition frequency	$I_C = –100$ mA; $V_{CE} = –1$ V; f = 100 MHz	50	–	MHz

PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads **SOT223**



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1	b_p	b_1	c	D	E	e	e_1	H_E	L_p	Q	v	w	y
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT223						~~96-11-11~~ 97-02-28

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

NOTES

NOTES

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